



Silicon N-Channel Power MOSFET



CR20N65F A9K

General Description:

CR20N65F A9K, the silicon N-channel Enhanced VDMOSFETs, is obtained by the self-aligned planar Technology which reduce the conduction loss, improve switching performance and enhance the avalanche energy. The transistor can be used in various power switching circuit for system miniaturization and higher efficiency. The package form is TO-220F, which accords with the RoHS standard.

Features:

- Fast Switching
- Low ON Resistance
- Low Gate Charge
- Low Reverse transfer capacitances
- 100% Single Pulse avalanche energy Test

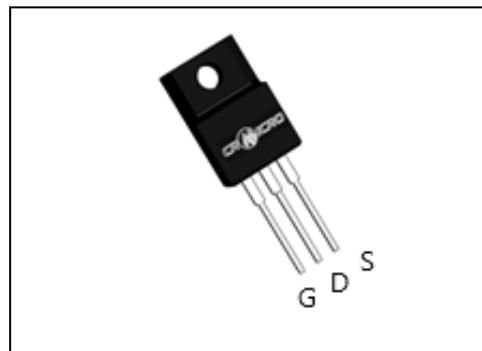
Applications:

Power switch circuit of adaptor and charger.

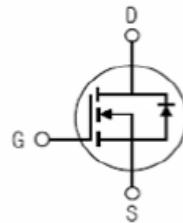
Absolute ($T_c = 25^\circ\text{C}$ unless otherwise specified):

Symbol	Parameter	Rating	Units
V_{DSS}	Drain-to-Source Voltage	650	V
I_D	Continuous Drain Current	20	A
	Continuous Drain Current $T_c = 100^\circ\text{C}$	12.5	A
I_{DM}^{a1}	Pulsed Drain Current	80	A
V_{GS}	Gate-to-Source Voltage	± 30	V
E_{AS}^{a2}	Single Pulse Avalanche Energy	830	mJ
dv/dt^{a3}	Peak Diode Recovery dv/dt	5.0	V/ns
P_D	Power Dissipation	45	W
	Derating Factor above 25°C	0.36	W/ $^\circ\text{C}$
T_J, T_{stg}	Operating Junction and Storage Temperature Range	150, -55 to 150	$^\circ\text{C}$

V_{DSS}	650	V
I_D	20	A
$P_D(T_c=25^\circ\text{C})$	45	W
$R_{DS(ON)}^{\text{Typ}}$	0.43	Ω



Inner Equivalent Principium Chart





CR20N65F A9K


Electrical Characteristics (T_J= 25°C unless otherwise specified):

OFF Characteristics						
Symbol	Parameter	Test Conditions	Rating			Unit
			Min.	Typ.	Max.	
V _{DSS}	Drain to Source Breakdown Voltage	V _{GS} =0V, I _D =250μA	650	--	--	V
Δ BV _{DSS} / Δ T _J	Bvdss Temperature Coefficient	I _D =250μA, Reference 25°C	--	0.7	--	V/°C
I _{DSS}	Drain to Source Leakage Current	V _{DS} = 650V, V _{GS} = 0V, T _J = 25°C	--	--	1	μA
		V _{DS} = 520V, V _{GS} = 0V, T _J = 125°C	--	--	100	μA
I _{GSS(F)}	Gate to Source Forward Leakage	V _{GS} = +30V	--	--	100	nA
I _{GSS(R)}	Gate to Source Reverse Leakage	V _{GS} = -30V	--	--	-100	nA

ON Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
R _{DS(ON)}	Drain-to-Source On-Resistance	V _{GS} =10V, I _D =10A	--	0.43	0.5	Ω
V _{GS(TH)}	Gate Threshold Voltage	V _{DS} = V _{GS} , I _D = 250 μA	2.0	--	4.0	V
Pulse width tp ≤ 300 μs, δ ≤ 2%						

Dynamic Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
R _g	Gate resistance	f = 1.0MHz	--	2.2	--	Ω
g _{fs}	Forward Transconductance	V _{DS} =15V, I _D =10A	--	16	--	S
C _{iss}	Input Capacitance	V _{GS} = 0V V _{DS} = 25V f = 1.0MHz	--	2995	--	pF
C _{oss}	Output Capacitance		--	1995	--	
C _{rss}	Reverse Transfer Capacitance		--	6.1	--	

Resistive Switching Characteristics						
Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
t _{d(ON)}	Turn-on Delay Time	I _D = 20A V _{DD} = 325V R _G = 10Ω	--	29	--	ns
t _r	Rise Time		--	60	--	
t _{d(OFF)}	Turn-Off Delay Time		--	61	--	
t _f	Fall Time		--	52	--	
Q _g	Total Gate Charge	I _D = 20A V _{DD} = 520V V _{GS} = 10V	--	52	--	nC
Q _{gs}	Gate to Source Charge		--	14	--	
Q _{gd}	Gate to Drain ("Miller") Charge		--	16	--	



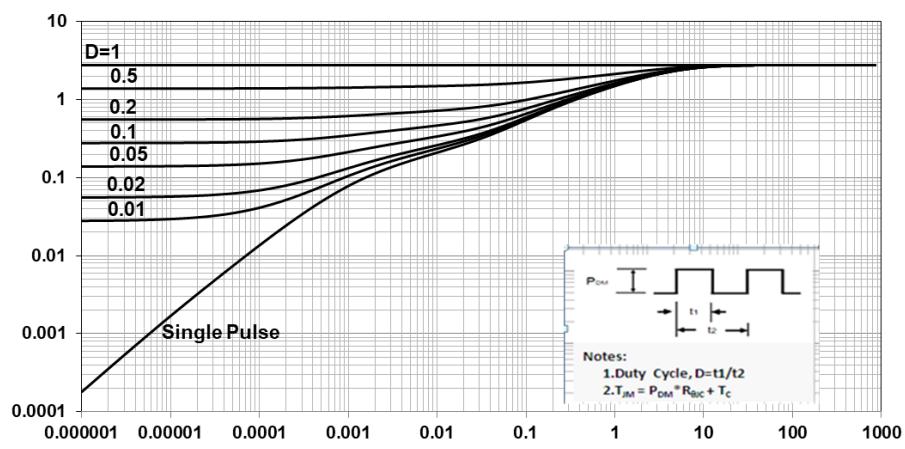
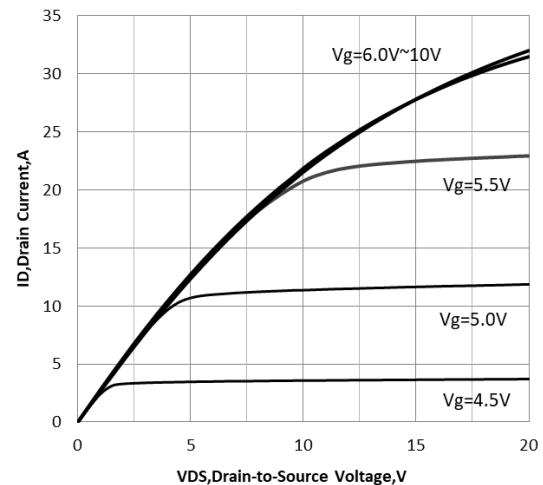
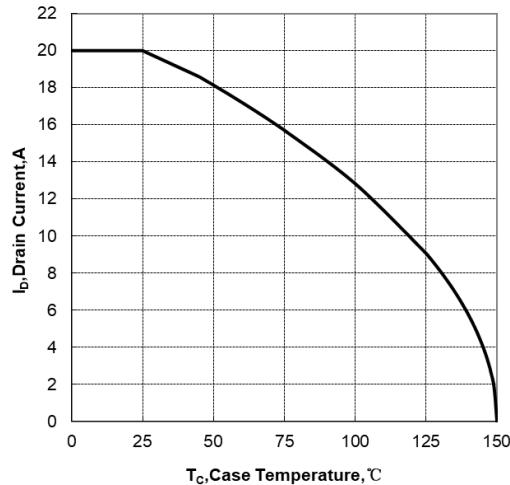
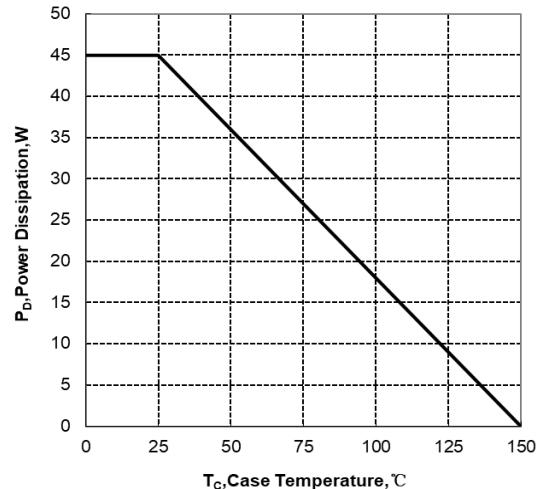
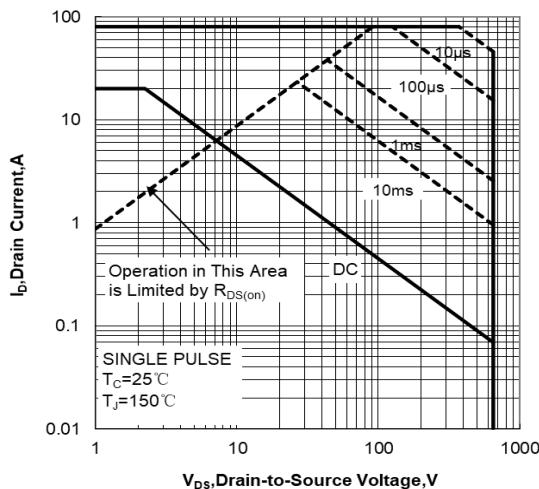
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**Source-Drain Diode Characteristics**

Symbol	Parameter	Test Conditions	Rating			Units
			Min.	Typ.	Max.	
I _S	Continuous Source Current (Body Diode)		--	--	20	A
I _{SM}	Maximum Pulsed Current (Body Diode)		--	--	80	A
V _{SD}	Diode Forward Voltage	I _S =20A, V _{GS} =0V	--	--	1.5	V
trr	Reverse Recovery Time	I _S =20A, T _j = 25°C dI _F /dt=100A/us, V _{GS} =0V	--	924	--	ns
Qrr	Reverse Recovery Charge		--	11.6	--	uC
I _{RRM}	Reverse Recovery Current		--	25	--	A
Pulse width t _p ≤300μs, δ ≤2%						
Symbol	Parameter		Max.			Units
R _{θJC}	Junction-to-Case		2.78			°C/W
R _{θJA}	Junction-to-Ambient		62.5			°C/W

^{a1}: Repetitive rating; pulse width limited by maximum junction temperature^{a2}: L=10mH, I_D=12.9A, Start T_j=25°C^{a3}: I_{SD}=20A,di/dt ≤100A/us,V_{DD}≤BV_{DS}, Start T_j=25°C

Characteristics Curve:



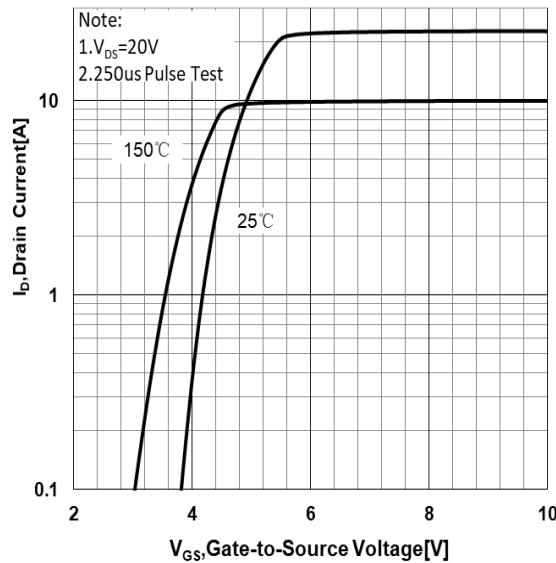


Figure.6 Typical Transfer Characteristics

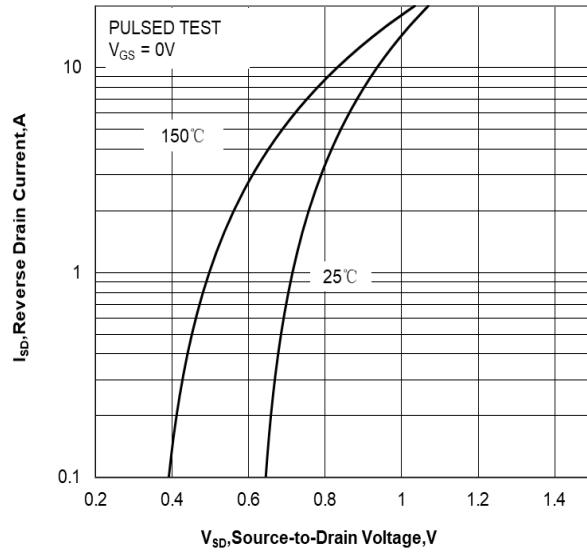


Figure.7 Typical Body Diode Transfer Characteristics

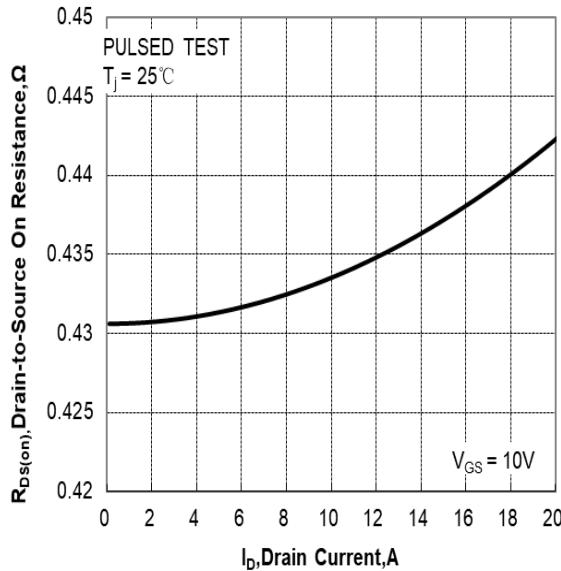


Figure.8 Typical Drain to Source ON Resistance vs Drain Current

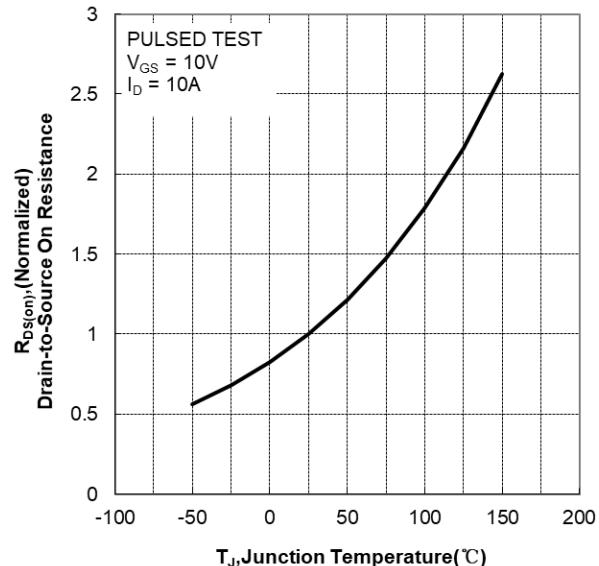


Figure.9 Typical Drian to Source on Resistance vs Junction Temperature

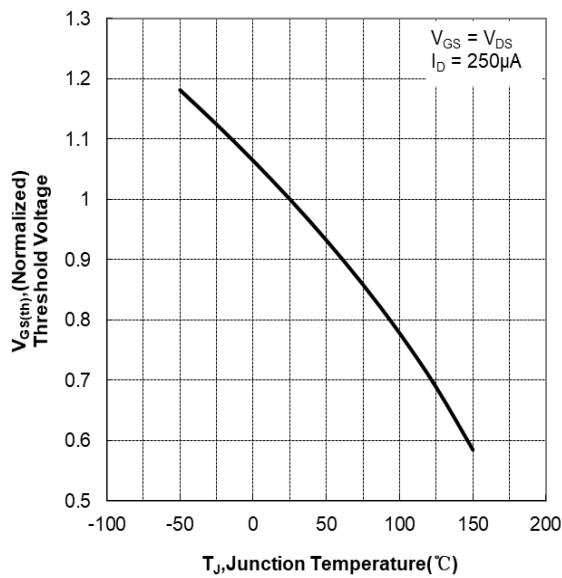


Figure.10 Typical Threshold Voltage vs Junction Temperature

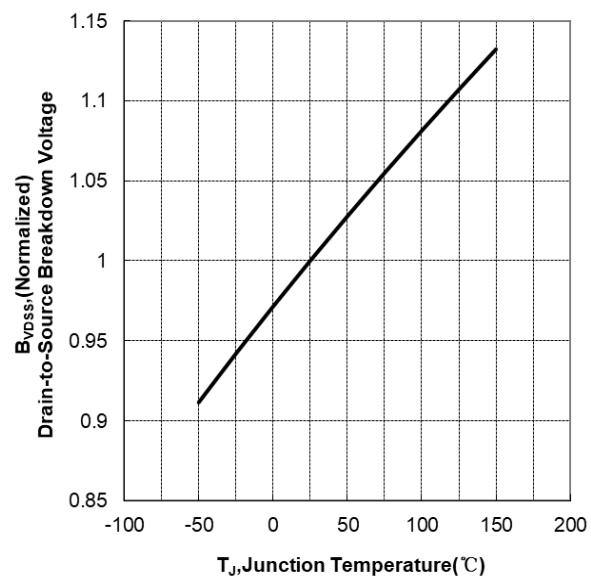


Figure 11 Typical Breakdown Voltage vs Junction Temperature

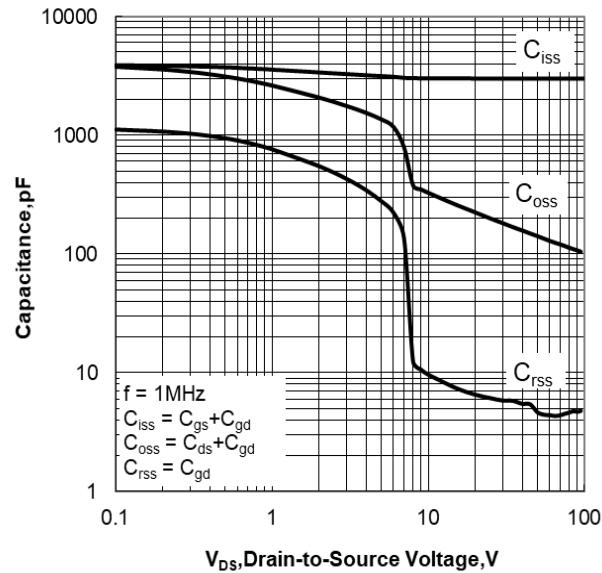


Figure.12 Typical Capacitance vs Drain to Source Voltage

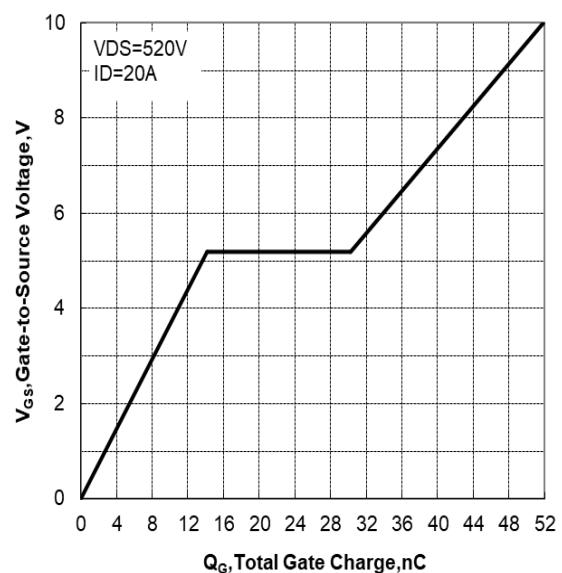


Figure.13 Typical Gate Charge vs Gate to Source Voltage

Test Circuit and Waveform

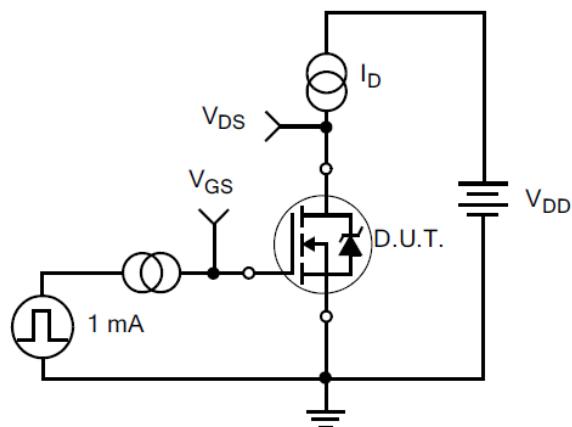


Figure 14. Gate Charge Test Circuit



Figure 15. Gate Charge Waveforms



Figure 16. Resistive Switching Test Circuit

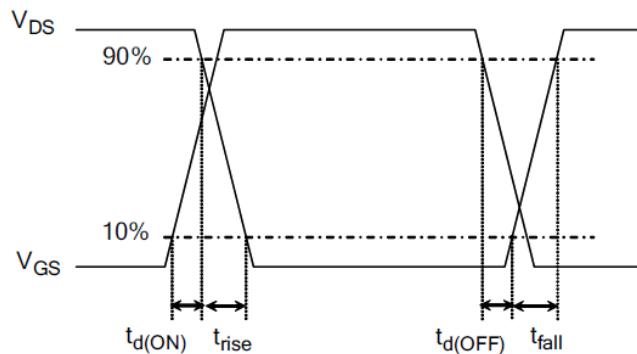


Figure 17. Resistive Switching Waveforms

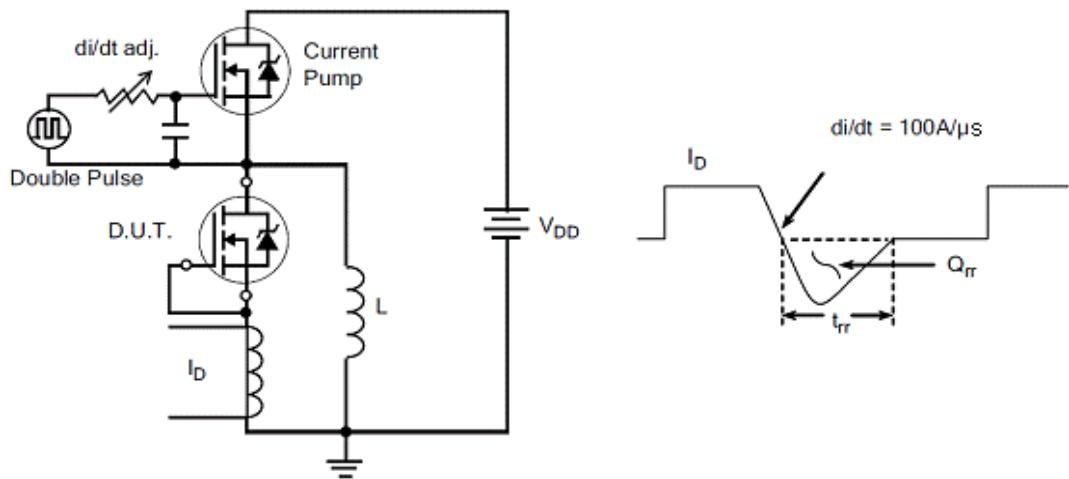


Figure 18. Diode Reverse Recovery Test Circuit

Figure 19. Diode Reverse Recovery Waveform

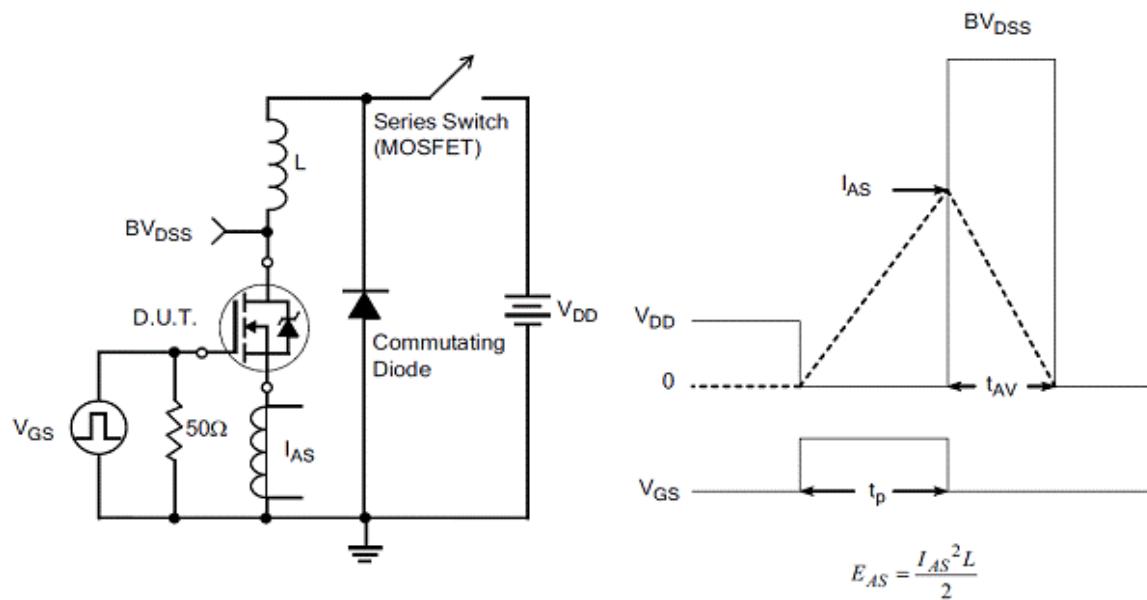
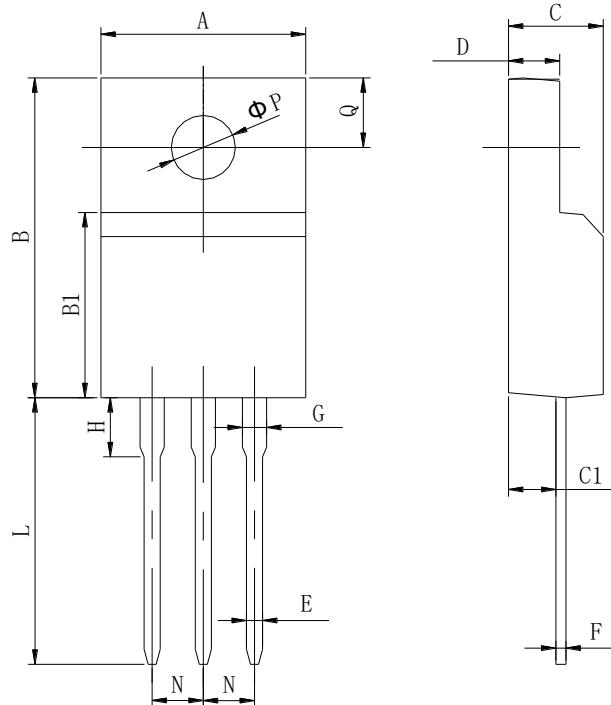


Figure20.Unclamped Inductive Switching Test Circuit

Figure21.Unclamped Inductive Switching Waveform

Package Information



Items	Values(mm)	
	MIN	MAX
A	9.60	10.4
B	15.4	16.2
B1	8.90	9.50
C	4.30	4.90
C1	2.10	3.00
D	2.40	3.00
E	0.60	1.00
F	0.30	0.60
G	1.12	1.42
H	3.40	3.80
L	12.0	14.0
N	2.34	2.74
Q	3.15	3.55
ΦP	2.90	3.30

TO-220F Package



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**The name and content of poisonous and harmful material in products**

Part's Name	Hazardous Substance									
	Pb	Hg	Cd	Cr(VI)	PBB	PBDE	DIBP	DEHP	DBP	BBP
Limit	≤ 0.1%	≤ 0.1%	≤ 0.01%	≤0.1%	≤0.1%	≤0.1%	≤0.1%	≤0.1%	≤0.1%	≤0.1%
Lead Frame	○	○	○	○	○	○	○	○	○	○
Molding	○	○	○	○	○	○	○	○	○	○
Chip	○	○	○	○	○	○	○	○	○	○
Wire Bonding	○	○	○	○	○	○	○	○	○	○
Solder	×	○	○	○	○	○	○	○	○	○
Note	<p>○: Means the hazardous material is under the criterion of 2011/65/EU. ×: Means the hazardous material exceeds the criterion of 2011/65/EU. The plumbum element of solder exist in products presently, but within the allowed range of Eurogroup's RoHS.</p>									

Warnings

1. Exceeding the maximum ratings of the device in performance may cause damage to the device, even the permanent failure, which may affect the dependability of the machine. It is suggested to be used under 80 percent of the maximum ratings of the device.
2. When installing the heatsink, please pay attention to the torsional moment and the smoothness of the heatsink.
3. VDMOSFETs is the device which is sensitive to the static electricity, it is necessary to protect the device from being damaged by the static electricity when using it.
4. This publication is made by Huajing Microelectronics and subject to regular change without notice.

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